# SONY

CXP5076/5078

CMOS 4-bit Single Chip Microcomputer

Description

CXP5076/5078 is a CMOS 4-bit microcomputer which consists of 4-bit CPU, ROM, RAM, I/O port, 8-bit timer, 8-bit timer/counter, 18-bit time base timer, 8-bit serial I/O, vector interruption, power on reset function, liquid crystal displayer (LCD) controller/driver, D/A conversion 14-bit PWM output port, a remote control reception circuit with noise eliminating circuit, 3-bit A/D converters, a 32kHz timer/event counter and a power supply voltage detection reset function. They are integrated into a single chip with the standby function, etc. which are to be operated at a low power consumption.
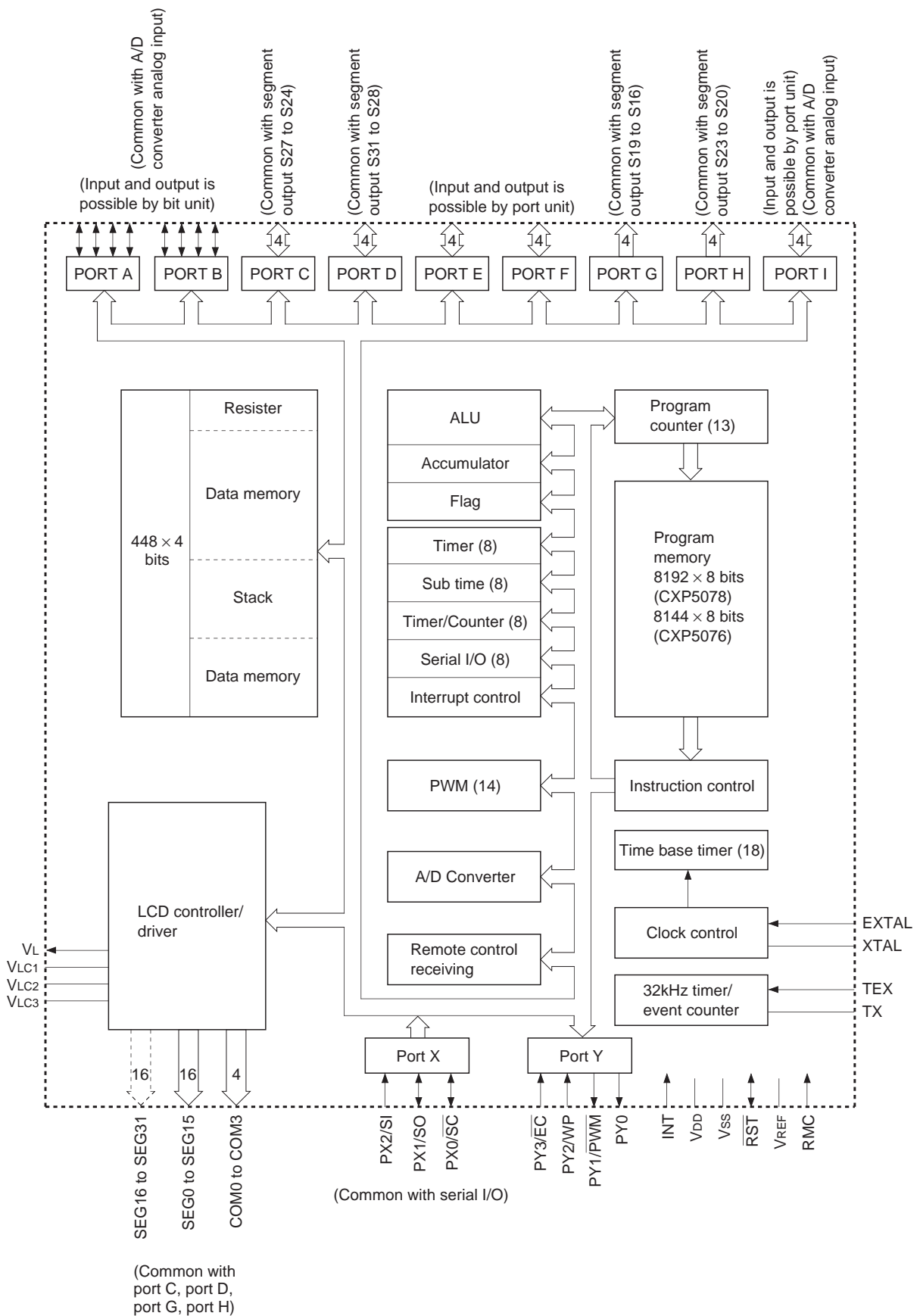
80 pin QFP (Plastic)
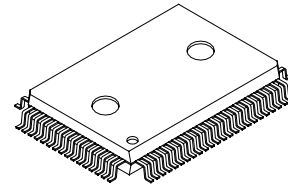
Features

- Instruction cycle   1.9µs/4.19MHz
  122 µs/32kHz
  (Possible to select with the program)
- ROM capacity   8192 × 8 bits (CXP5078)
  6144 × 8 bits (CXP5076)
- RAM capacity   448 × 4 bits (Including stack, display area)
- 43 general purpose I/O ports
- 8 high current output ports
- LCD controller/driver (Possible to direct drive)
  — Possible to select with the program the segment output of 16 to 32
  — Possible to select with the program the duty of static, 1/2, 1/3 and 1/4
  — Possible to select with the program the bias of 1/2, 1/3
- 14-bit PWM output for D/A conversion
- Remote control reception circuit
- 3-bit A/D converter (8 channels per circuit)
- 32kHz timer/event counter
- Power supply voltage detection reset function
- Low voltage operation (2.5V) ..... when operating in 122µs/32kHz
- Rich wake-up function
- 8-bit/4-bit variable serial I/O
- Arithmetic and logical operations possible between the entire ROM area, I/O area and the accumulator by means of the memory mapped I/O
- 8-bit timer, 8-bit timer/event counter and 18-bit time base timer, independently controlled
- 2 kinds of power down modes of sleep and stop
- Power on reset circuit (mask option)
- Provided with 80 pin plastic QFP
- Provided with 80 pin piggyback QFP (CXP5070)
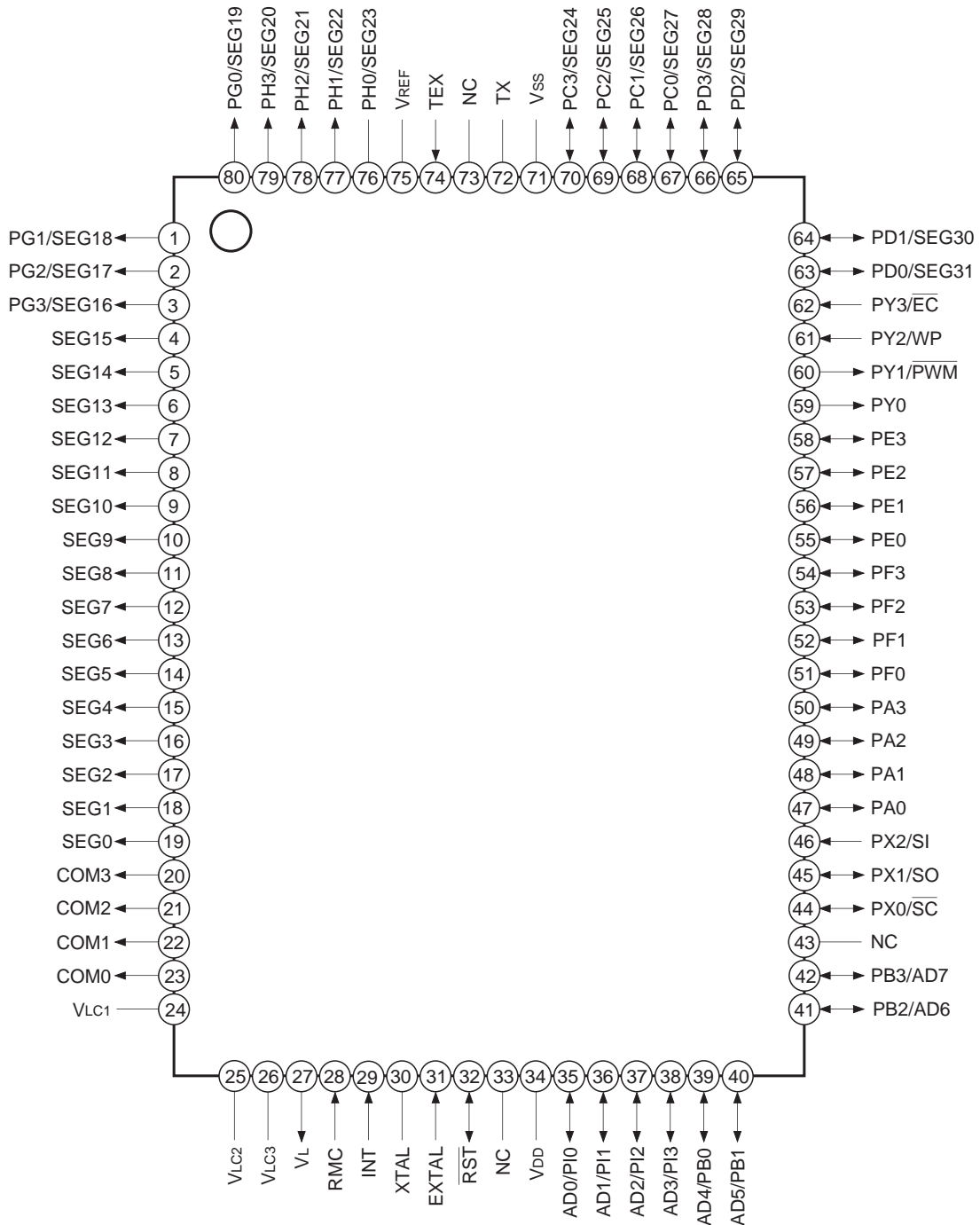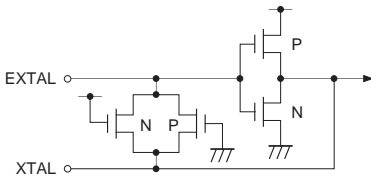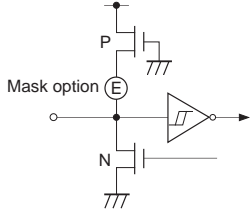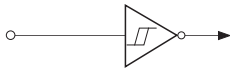
Structure

Silicon gate CMOS IC

– 1 –

E88037A78-PS

Block Diagram
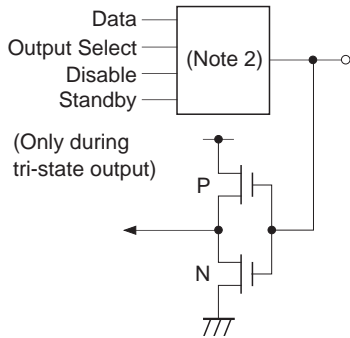
Pin Configuration (Top View)

Top pins (80–65):
PG0/SEG19 (80), PH3/SEG20 (79), PH2/SEG21 (78), PH1/SEG22 (77), PH0/SEG23 (76), V$_{REF}$ (75), TEX (74), NC (73), TX (72), V$_{SS}$ (71), PC3/SEG24 (70), PC2/SEG25 (69), PC1/SEG26 (68), PC0/SEG27 (67), PD3/SEG28 (66), PD2/SEG29 (65)

Left pins (1–24):
PG1/SEG18 (1)
PG2/SEG17 (2)
PG3/SEG16 (3)
SEG15 (4)
SEG14 (5)
SEG13 (6)
SEG12 (7)
SEG11 (8)
SEG10 (9)
SEG9 (10)
SEG8 (11)
SEG7 (12)
SEG6 (13)
SEG5 (14)
SEG4 (15)
SEG3 (16)
SEG2 (17)
SEG1 (18)
SEG0 (19)
COM3 (20)
COM2 (21)
COM1 (22)
COM0 (23)
V$_{LC1}$ (24)

Right pins (64–41):
PD1/SEG30 (64)
PD0/SEG31 (63)
PY3/$\overline{EC}$ (62)
PY2/WP (61)
PY1/$\overline{PWM}$ (60)
PY0 (59)
PE3 (58)
PE2 (57)
PE1 (56)
PE0 (55)
PF3 (54)
PF2 (53)
PF1 (52)
PF0 (51)
PA3 (50)
PA2 (49)
PA1 (48)
PA0 (47)
PX2/SI (46)
PX1/SO (45)
PX0/$\overline{SC}$ (44)
NC (43)
PB3/AD7 (42)
PB2/AD6 (41)

Bottom pins (25–40):
V$_{LC2}$ (25), V$_{LC3}$ (26), V$_L$ (27), RMC (28), INT (29), XTAL (30), EXTAL (31), $\overline{RST}$ (32), NC (33), V$_{DD}$ (34), AD0/PI0 (35), AD1/PI1 (36), AD2/PI2 (37), AD3/PI3 (38), AD4/PB0 (39), AD5/PB1 (40)

Note) Do not make any connections to NC pins.

Pin Description

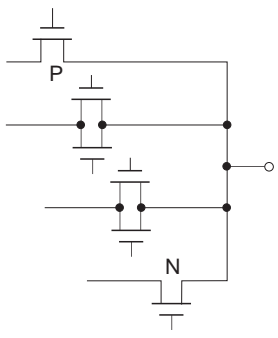| Symbol	Name	I/O	Equivalent Circuit	Description
VDD	Supply voltage	—		Positive voltage supply pin
VSS	Grounding voltage	—		GND pin
EXTAL	Clock input	I		Clock oscillation circuit input pin. Connect the crystal oscillator or ceramic resonator between the EXTAL and XTAL. When using as the external clock input, connect the clock oscillation source to the EXTAL pin and open the XTAL pin.
XTAL	Clock output	O		Clock oscillation circuit output pin
$\overline{RST}$	Reset	I/O	Output pull-up resistor (P-ch Tr) N-ch Tr output Schmitt inverter input	Serves as the incorporated power-on reset circuit output pin. When inputting a reset signal from the outside, provide 2 instruction cycles or longer of an "L" level (0V).
INT	External interrupt	I		Serves the interrupt input pin. Permits the selection with a program of the edge and the level modes.
RMC	Remote control input	I	Schmitt inverter input	Remote control receiver input pin
PX2/SI	Port X2 Serial input	I		Doubles as a serial interface (8 bits) input pin and as bit "2" (input) of port X.
PX1/SO	Port X1 Serial output	I/O	See Note 2) for the output circuit format. Inverter input	Doubles as a serial interface (8 bits) output pin and as bit "1" (input) of port X. (SO output possible to inhibit with the program.)

Symbol	Name	I/O	Equivalent Circuit	Description
PX0/$\overline{SC}$	Port X0 Serial clock	I/O	Data — Output Select — Disable — Standby — (Note 2) (Only during tri-state output) Schmitt inverter input See Note 2) for the output circuit format. Schmitt inverter input	Doubles as shift clock input/output pin for the serial interface and as bit "0" (input) of port X.
PY3/$\overline{EC}$	Port Y3 Event count input	I	Schmitt inverter input	Doubles as event counter (8 bits) input pin and as bit "3" (input) of port Y.
PY2/WP	Port Y2 Wake-up input	I		Doubles as wake-up input pin to release the standby state and as bit "2" (input) of port Y.
PY1/$\overline{PWM}$	Port Y1 PWM generator output	O	Data — Output Select — (Note 1) Disable — See Note 1) for the output circuit format.	Doubles as PWM generator (14 bits) output pin and as bit "1" (output) of port Y.
PY0	Port Y0	O		Output pin for bit "0" of port Y.
PA0 to PA3	Port A	I/O	Data — Output Select — Disable — Standby — (Note 2) (Only during tri-state output) P N See Note 2) for the output circuit format. Inverter input	This 4-bit input/output port permits its each individual bit to be programmed to serve either as input or output. For the output format, a tri-state and pull-up resistor possible to be programmed, and it is also used as the standby resetting pin.
PB0/AD4 to PB3/AD7	Port B Analog voltage input	I/O		This 4-bit input/output port has the functions that are equivalent to those of port A. It is also used for A/D converter input.
PE0 to PE3	Port E	I/O		This 4-bit input/output port permits its each individual port to be programmed to serve either as input or output. For the output format, a tri-state and pull-up resistor possible to be programmed.
PF0 to PF3	Port F	I/O		This 4-bit input/output port has the functions that are equivalent to those of port E.
PI0/AD0 to PI3/AD3	Port I Analog voltage input	I/O		This 4-bit input/output port has the functions that are equivalent to those of port E. It is also used for A/D converter input.

Symbol	Name	I/O	Equivalent Circuit	Description
PD3/ SEG31 to PD0/ SEG28	Port D Segment output	O	The transfer gate input signal is controlled based on 1/2, 1/3 bias method in advance. Data — Output Select — Standby — LCD/PORT select — (Note 3) — Port C, D, G, H See Note 3) for the output circuit format.	Doubles as a 4-bit output port (For the output format, the inverter and pull-up resistor possible to be programmed.) and as the segment signal output pin for LCD.
PC3/ SEG27 to PC0/ SEG24	Port C Segment output	O		Doubles as a 4-bit output port (The output format is equivalent to port D.) and as the segment signal output pin for LCD.
PH3/ SEG23 to PH0/ SEG20	Port H Segment output	O		Doubles as a 4-bit output port (The output format is equivalent to port D.) and as the segment signal output pin for LCD. (Possible to designate in bit units.)
PG3/ SEG19 to PG0/ SEG16	Port G Segment output	O		Doubles as a 4-bit output port (The output format is equivalent to port D.) and as the segment signal output pin for LCD.
SEG0 to SEG15	Segment output	O	The transfer gate input signal is controlled based on 1/2, 1/3 bias methods in advance.	Segment signal output pin for LCD
COM0 to COM3	Common output	O	Transfer gate output	Common signal output pin for LCD
V_{LC1} to V_{LC3}	Power supply for LCD	—		Bias power supply pin for LCD
V_L	Cut-off output	O		Control pin which cuts off the current input to the bias resistor for the external LCD during standby.

Symbol	Name	I/O	Equivalent Circuit	Description
WP	Wake-up input	I	Schmitt inverter input	It is the input pin to release the standby mode, and release by "1".
TEX	32kHz T/C clock input	I	Mask option TEX P N P N TX	Input pin for 32kHz timer clock generation circuit. Connect the 32.768kHz crystal oscillator between TEX and TX. When using as the event clock input, connect the clock oscillation source to the TEX pin, open the TX pin.
TX	32kHz T/C clock output	O		Output of clock generation circuit
V_{REF}	Reference voltage input	I		Reference voltage input for power supply voltage resetting circuit. Connect the zener diode normally.

For all output ports, the output states of ports during standby possible to be programmed to the state holding before standby or the change to the high impedance.

When the pull-up resistor output is selected, it becomes a pulled-up state even it is input port.

During standby, it is impossible to change to the high impedance of PY0 and PY1 in the inverter output state. To change to the high impedance, select the pull-up resistor output, and then set to the high level output ("1" state).

Note 1) Possible to select out of the following two ways for the output circuit format.

　　　　(port units: programmable)
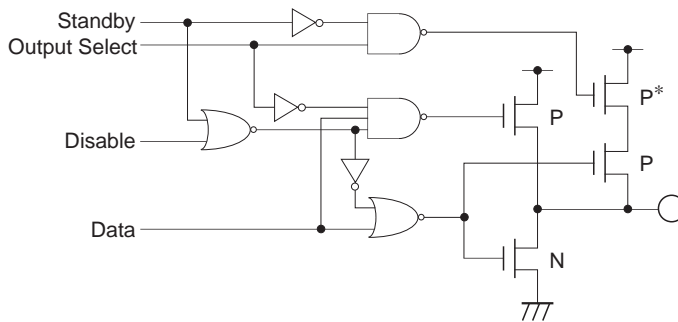
　　　　　(a) Inverter output

　　　　　(b) Pull-up resistor output
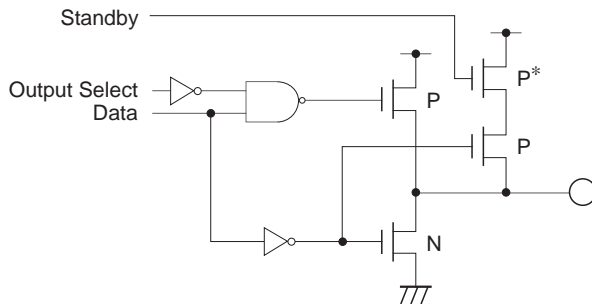
Note 2) Possible to select out of the following two ways for the output circuit format.

　　　　(port units: programmable)
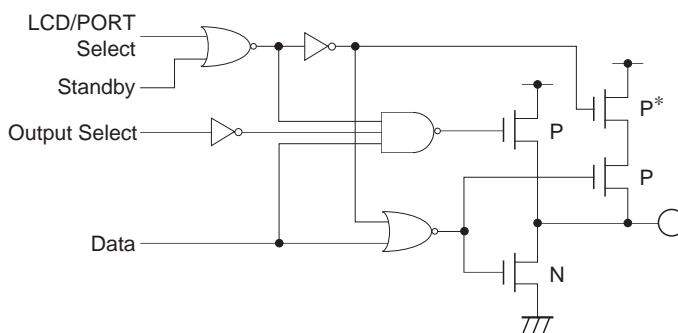
　　　　　(a) Tri-state output

　　　　　(b) Pull-up resistor output

Note 3) Possible to select out of the following two ways for the output circuit format.

　　　　(port units: programmable)

　　　　　(a) Inverter output

　　　　　(b) Pull-up resistor output

* As the output pull-up resistor is CMOS pull-up output of about 10kΩ, the pull-up resistor becomes OFF state during "L" output.

Absolute Maximum Ratings   (Ta = −20 to +75°C, Vss = 0V)

Item	Symbol	Rating	Unit	Remarks
Power supply voltage	V_{DD}	−0.3 to +7.0	V	
LCD bias voltage	V_{CL1}, V_{CL2}, V_{CL3}	−0.3 to +7.0[*1]	V	
Input voltage	V_{IN}	−0.3 to +7.0[*1]	V	
Output voltage	V_{OUT}	−0.3 to +7.0[*1]	V	
High level output current	I_{OH}	−5	mA	General purpose port[*2]: per pin
High level total output current	ΣI_{OH}	−50	mA	Entire pins total
Low level output current	I_{OL}	15	mA	General purpose port[*2]: per pin
	I_{OLC}	20	mA	High current port[*3]: per pin
Low level total output current	ΣI_{OL}	100	mA	Entire pins total
Operating temperature	Topr	−20 to +75	°C	
Storage tamperature	Tstg	−55 to +150	°C	
Allowable power dissipation	P_D	600	mW	

[*1] V_{LC1}, V_{LC2}, V_{LC3}, V_{IN} and V_{OUT} should not exceed V_{DD} + 0.3V.

[*2] Specifies the output current of the general purpose I/O port PA to PI, SO, $\overline{SC}$, PY0 and PY1.

[*3] The high current operation transistors are the N-ch transistors of the PC and PD ports.

Note)   Usage exceeding absolute maximum ratings may permanently impair the LSI. Normal operation should better take place under the recommended operation conditions. Exceeding those conditions may adversely affect the reliability of the LSI.

Recommended Operating Condition   (Vss = 0V)

Item	Symbol	Min.	Max.	Unit	Remarks
Power supply voltage	V_{DD}	4.5	5.5	V	Guaranteed range of operation by EXTAL clock
		2.5	5.5	V	Guaranteed range of operation by TEX clock, guaranteed range of data hold during STOP.
LCD bias voltage	V_{CL1}, V_{CL2}, V_{CL3}	V_{SS}	V_{DD}	V	Liquid crystal power supply range[*1]
High level input voltage	V_{IH}	$0.7V_{DD}$	V_{DD}	V	
	V_{IHS}	$0.8V_{DD}$	V_{DD}	V	Hysteresis input[*2]
	V_{IHEX}	$V_{DD} − 0.4$	$V_{DD} + 0.3$	V	EXTAL pin[*3]
Low level input voltage	V_{IL}	0	$0.3V_{DD}$	V	
	V_{ILS}	0	$0.2V_{DD}$	V	Hysteresis input[*2]
	V_{ILEX}	−0.3	0.4	V	EXTAL pin[*3]
Operating temperature	Topr	−20	+75	°C	

[*1] The optimum value is determined by the characteristics of the liquid crystal display element used.

[*2] The TEX pin when the counter mode is selected by each of INT, RMC, PX0, PX2, PY2, PY3, $\overline{RST}$ pins and mask option.

[*3] Specified only during external clock input.

Electrical Characteristics

DC characteristics   (Ta = −20 to +75°C, Vss = 0V)

Item	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit
High level output voltage	V_{OH}	PA to PI[1] PX0, PX1 PY0, PY1	V_{DD} = 4.5V, I_{OH} = −0.5mA[2]	4.0			V
			V_{DD} = 4.5V, I_{OH} = −1.0mA[2]	3.5			V
			V_{DD} = 4.5V, I_{OH} = −10µA[3]	4.0			V
			V_{DD} = 4.5V, I_{OH} = −200µA[3]	2.4			V
Low level output voltage	V_{OL}	VL (V_{OL} only) $\overline{RST}$ (V_{OL} only) PC[1], PD[1]	V_{DD} = 4.5V, I_{OL} = 1.8mA			0.4	V
			V_{DD} = 4.5V, I_{OL} = 3.6mA			0.6	V
			V_{DD} = 4.5V, I_{OL} = 12mA			1.5	V
Input current	I_{IHE}	EXTAL	V_{DD} = 5.5V, V_{IH} = 5.5V	0.5		40	µA
	I_{ILE}		V_{DD} = 5.5V, V_{IL} = 0.4V	−0.5		−40	µA
	I_{IHT}	TEX[4]	V_{DD} = 5.5V, V_{IH} = 5.5V	0.1		10	µA
	I_{ILT}		V_{DD} = 5.5V, V_{IL} = 0.4V	−0.1		−10	µA
	I_{ILR}	$\overline{RST}$[5]		−1.5		−400	µA
	I_{IL}	$\overline{PA}$[6], PB[6], PE[6], PF[6], PI[6], PX0[6]				±10	µA
High impedance I/O leakage current	I_{IZ}	PX1[6], PX2[8], PY0[7], PY1[7], PY2[8], PY3[8], $\overline{INT}$[8], RMC[8], $\overline{RST}$[5], TEX[4]	V_{DD} = 5.5V, V_I = 0, 5.5V			±10	µA
Common output impedance	R_{COM}	COM0 to COM3	V_{DD} = 5V V_{LC1} = 3.75V V_{LC2} = 2.5V V_{LC3} = 1.25V		3	5	kΩ
Segment output impedance	R_{SEG}	SEG0 to SEG15 SEG16 to SEG31[1]			5	15	kΩ
Supply current	I_{DD1}	V_{DD}	Entire output pins open / Crystal oscillation (C1 = C2 = 22pF) of V_{DD} = 5.5V, 4.19MHz		7	20	mA
	I_{DD2}		Crystal oscillation (C1 = C2 = 47pF) of V_{DD} = 3V, 32kHz		50	250	µA
	I_{DDSP1}		Sleep mode / V_{DD} = 5.5V, 4.19MHz oscillation		5	12	mA
	I_{DDSP2}		V_{DD} = 3V, 32kHz oscillation		40	200	µA
	I_{DDS1}		Stop mode / V_{DD} = 3V, 32kHz with T/C		7	40	µA
	I_{DDS2}		V_{DD} = 5.5V, 32kHz without T/C (For mask option select counter, Pin is fixed.)			10	µA
Input capacity	C_{IN}	Other than V_{LC1} to V_{LC3}, COM0 to COM3, SEG0 to SEG15, SEG16 to SEG31[1], Vss, V_{DD} pins	Clock 1MHz 0V other than the measured pins		10	20	pF

*[1] The PC, PD, PG and PH show when the combined pins are selected as the port, and SEG16 to SEG31 show when the combined pins are selected as the segment output.

*[2] It is when the respective pins of PA to PI, PX0 and PX1 select the tri-state output circuit, and PY0 and PY1 are when the inverter output circuit is selected.

*[3] It is when the respective pins of PA to PI, PX0, PX1, PY0 and PY1 select the pull-up resistor.

*[4] The TEX pin specifies the input current when the crystal oscillation is selected by the mask option, and specifies the leakage current when the schmitt input is selected.

*[5] The $\overline{RST}$ pin specifies the input current when the pull-up resistor is selected, and specifies leakage current when non-resistor is selected.

*[6] The respective pins of PA, PB, PE, PF, PI, PX0 and PX1 specify the input current when the pull-up resistor is selected, and specify the leakage current when the port state during using the tri-state output circuit or standby is selected at high impedance.

*[7] The respective pins of PY0 and PY1 specify the input current when the pull-up resistor is selected, and specify the leakage current when the port state during standby is selected at high impedance.

*[8] The respective pins of PX2, PY2, PY3, INT and RMC only specify the leakage current.

AC characteristics

(1) Clock timing   (Ta = −20 to +75°C, V_{DD} = 4.5 to 5.5V, Vss = 0V)

Item	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit
System clock frequency	f_c	XTAL EXTAL	Fig. 1, Fig. 2	1		5	MHz
System clock input pulse width	t_{XL} t_{XH}	EXTAL	Fig. 1, Fig. 2 (External clock drive)	90			ns
System clock input rising and falling times	t_{CR} t_{CF}					200	ns
System clock frequency	f_{CS}	TEX*[2] TX	V_{DD} = 2.5 to 5.5V Fig. 3		32.768		kHz
Event count clock input pulse width	t_{EL} t_{EH}	$\overline{EC}$	Fig. 4	tsys*[1] + 0.05			μs
Event count clock input rising and falling times	t_{ER} t_{EF}	$\overline{EC}$	Fig. 4			20	ms
Event count input clock input pulse width	t_{TL} t_{TH}	TEX*[3]	Fig. 4	10			μs
Event count input clock rising and falling times	t_{TR} t_{TF}	TEX*[3]	Fig. 4			20	ms

*[1] tsys in the EXTAL input clock is 8/fc.

tsys in the TEX input clock is 4/fcs.

*[2] Specified when the crystal oscillation mode is selected by the mask option.

*[3] Specified when the counter mode is selected by the mask option.

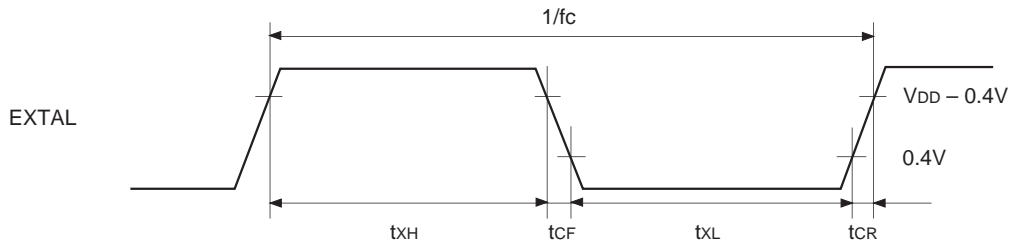**Note)** When adjusting the frequency accurately, there may be cases in which they may differ from Fig. 2.
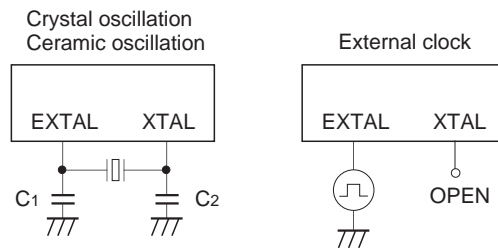
Fig. 1. Clock timing

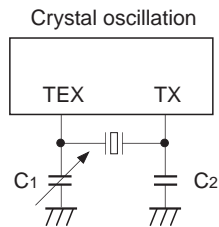

Fig. 2. Clock applying condition

Fig. 3. 32kHz clock applying condition

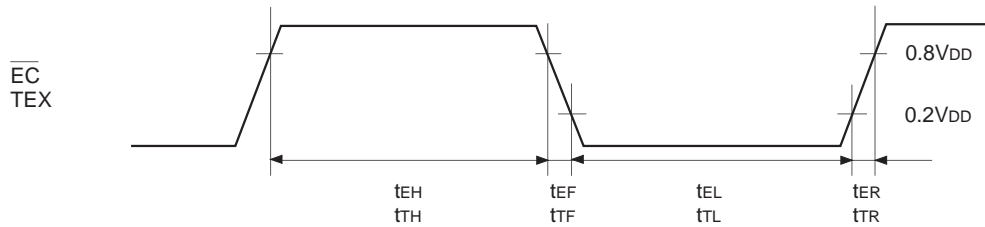**Fig. 4. Event count clock timing**

(2) Serial transfer   (Ta = −20 to +75°C, V$_{DD}$ = 4.5 to 5.5V, Vss = 0V)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
Serial transfer clock ($\overline{SC}$) cycle time	t$_{KCY}$	$\overline{SC}$	Input mode	tsys/4 + 1.42		μs
			Output mode	2tsys		μs
Serial transfer clock ($\overline{SC}$) high and low level widths	t$_{KH}$ t$_{KL}$	$\overline{SC}$	Input mode	tsys/8 + 0.7		μs
			Output mode*1	tsys − 0.1		μs
			Output mode*2	tsys − 1.6		μs
Serial data input setup time (against SC ↑)	t$_{SIK}$	SI	$\overline{SC}$ input mode	0.1		μs
			$\overline{SC}$ output mode	0.2		μs
Serial data input hold time (against SC ↑)	t$_{KSI}$	SI	$\overline{SC}$ input mode	tsys/8 + 0.5		μs
			$\overline{SC}$ output mode	0.1		μs
High data output delay time from $\overline{SC}$ falling*3	t$_{KSO}$	SO			tsys/8 + 0.5	μs
High data output delay time from $\overline{SC}$ falling*4	t$_{KSO}$	SO			tsys/8 + 1.6	μs
Low data output delay time from $\overline{SC}$ falling	t$_{KSO}$	SO			tsys/8 + 0.5	μs

Notes) 1. tsys in the EXTAL input clock is 8/fc. (It is impossible to use in TEX input clock.)
          2. The load of data output delay is 50pF + 1TTL.
*1 It is specified when PX0/$\overline{SC}$ pin is selected to the tri-state output by the program.
*2 It is specified when PX0/$\overline{SC}$ pin is selected to the pull-up resistance by the program.
    As the tsys receives restriction by this item, take notice that it limits the upper limit of the system clock frequency fc.
*3 This item is specified when PX1/SO pin is selected to the tri-state output by the program.
*4 This item is specified when PX1/SO pin is selected to the pull-up resistance by the program.
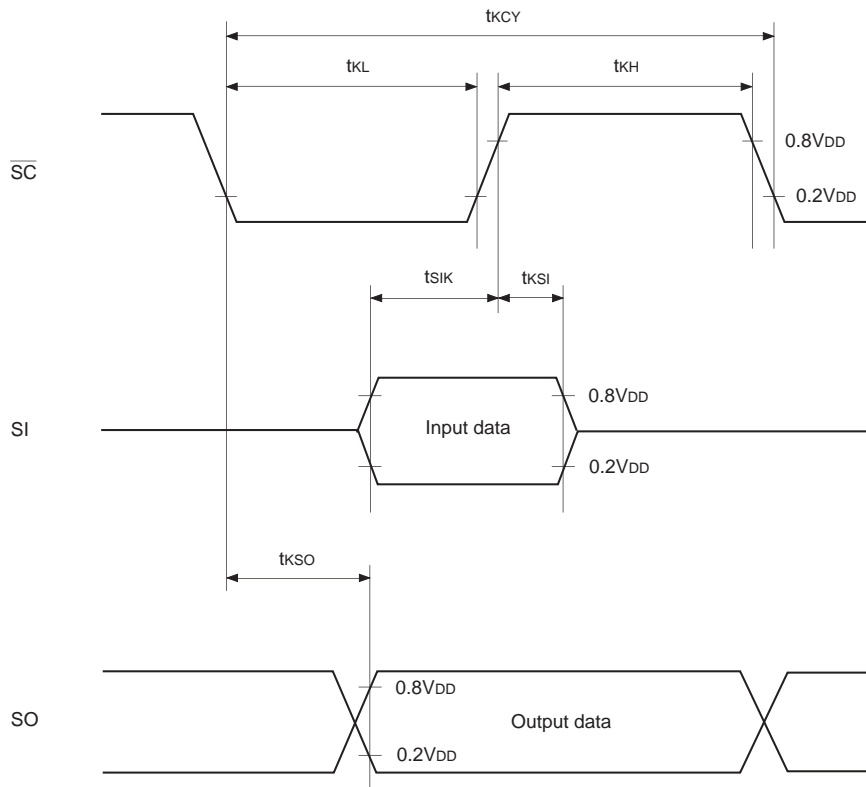

Fig. 5. Serial transfer timing

(3) A/D converter   (Ta = −20 to +75°C, Vss = 0V)

Analog input voltage	Pin	Condition	Digital conversion value
0.0 to 0.33V			000
0.82 to 1.29V			001
1.78 to 2.21V	AD0 to AD7	V_{DD} = 5V	010
2.69 to 3.06V			011
3.56 to 4.06V			100
4.62 to 5.0V			101

Note) The digital conversion value are the values when AB_H address of the RAM file 1 in the program are read.

(4) Power Supply Voltage Detection Reset Function   (Ta = −20 to + 75°C, Vss = 0V)

Item	Symbol	Pin	Condition	Min.	Typ.	Max.	Unit
Power supply voltage detection reset function of operation voltage range	V_{LPOP}	V_{DD}	Voltage range allowing system operation (32kHz system operation below V_{DD} = 4.5V)	2.5		5.5	V
Power supply voltage drop detection function	V_{POP}	V_{DD}	When V_{REF} pin voltage is 3.3V Flag set when voltage drops System reset when voltage rises	3.8	4.0	4.2	V

The graph in Fig. 6 shows the relationship between the power supply voltage V_{DD} and reference voltage V_{REF} of the power supply voltage detection reset function.

Note) The graph in Fig. 6 serves as guide to the function operation area obtained using average devices.
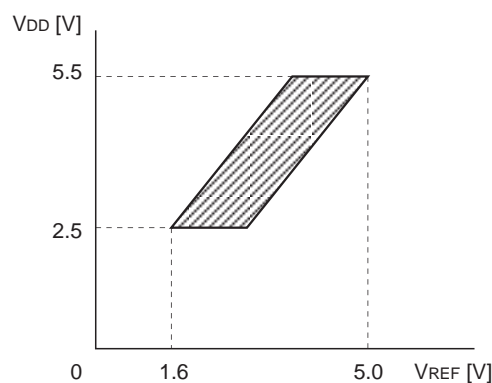   Individual adjustment is needed when Zener diodes, etc., are connected to the V_{REF} pin.

Fig. 6. Power supply voltage detection reset function chart

(5) Others   (Ta = −20 to +75°C, V$_{DD}$ = 4.5 to 5.5V, Vss = 0V)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
External interruption high and low level widths	t$_{I1H}$, t$_{I1L}$	INT	During edge detection mode	tsys + 0.05		μs
Reset input low level width	t$_{RSL}$	$\overline{RST}$		2tsys[*1]		μs
Wake-up input high level width	t$_{WPH}$	WP	Stop mode	500		ns
			Sleep mode	tsys + 0.05		μs
Wake-up input low level width	t$_{WPL}$	PA0 to PA3	Stop mode	500		ns
			Sleep mode	tsys + 0.05		μs

Note) tsys in the EXTAL input clock is 8/fc.
         tsys in the TEX input clock is 4/fcs.

[*1] For resetting when operating in TEX input clock, hold the low level more than the oscillation stabilizing time of EXTAL input clock.
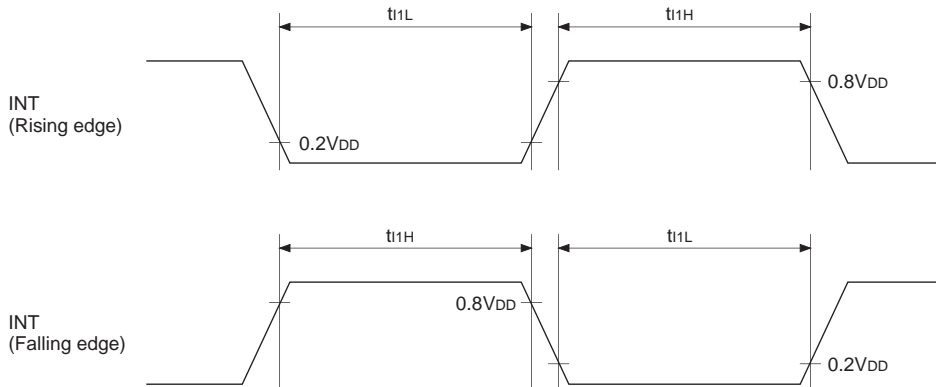
Fig. 7. Interruption input timing
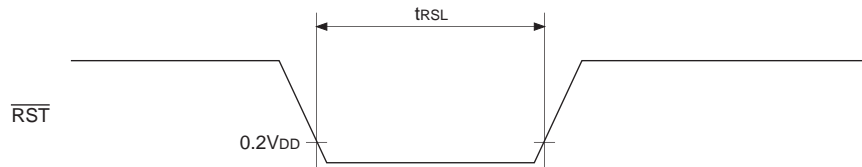
Fig. 8. Reset input timing
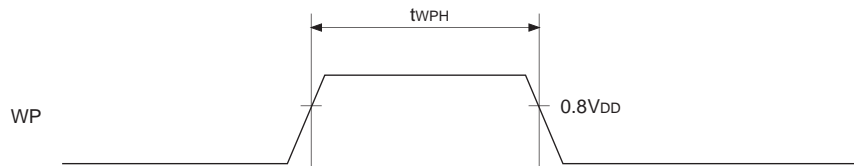
Fig. 9. Wake-up input timing
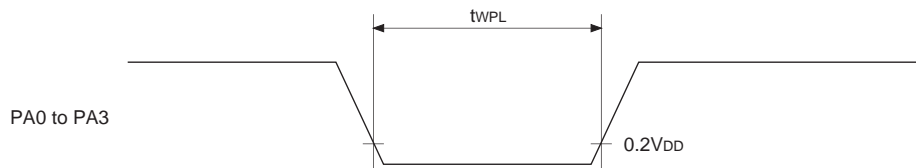
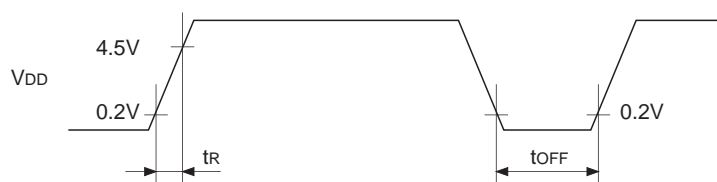**Fig. 10. Wake-up input timing**

Power on reset*

(Ta = −20 to +75°C, Vss = 0V)

Item	Symbol	Pin	Condition	Min.	Max.	Unit
Power supply rising time	t_R	V_{DD}	Power on reset	0.05	50	ms
Power supply cut-off time	t_{OFF}		Repetitive power on reset	1		ms

* Specifies only when power on reset function is selected.

The power supply should rise smoothly.

Fig. 11. Power on reset

Notes on Application

See Fig. 11, Additive capacity calculation chart, when using the crystal oscillator and select the appropriate capacity.

Ta = −20 to +75°C, V_{DD} = 4.5 to 5.5V
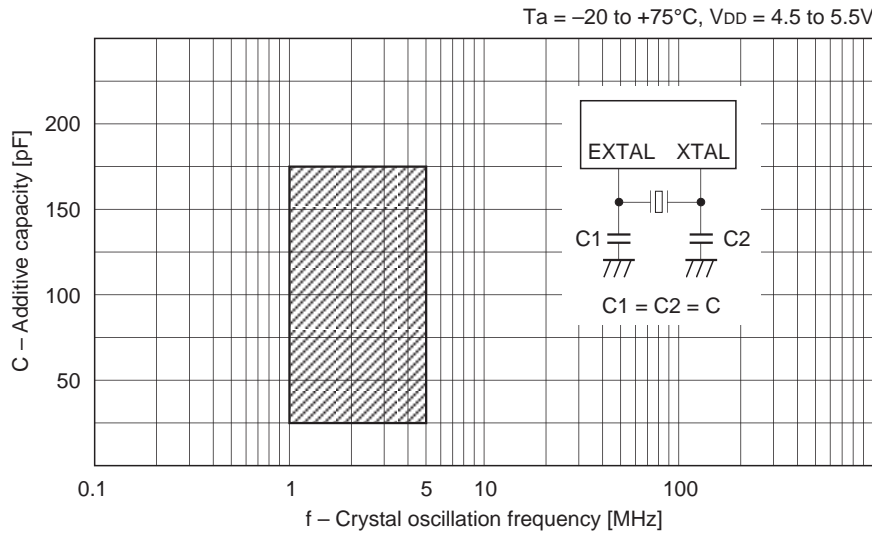
Fig. 12. Crystal oscillation circuit additive capacity calculation chart

Note) The above chart shows a range in which the average quartz resonator has a relatively fast oscillation rising edge and stable characteristics. The capacity should be selected to correspond to the appropriate constant for each quartz resonator, should the frequency of the quartz resonator be accurately adjusted.

Fig. 13 shows an example of a circuit which can accurately adjust the frequency. Used here a trimmer capacitor.
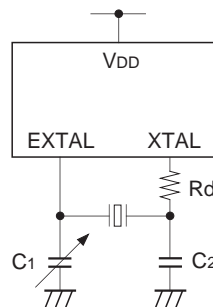

Fig. 13. Frequency adjustment circuit

When using the A/D converter as the key input, it is recommended that the circuit structure shown in Fig. 14 be used.
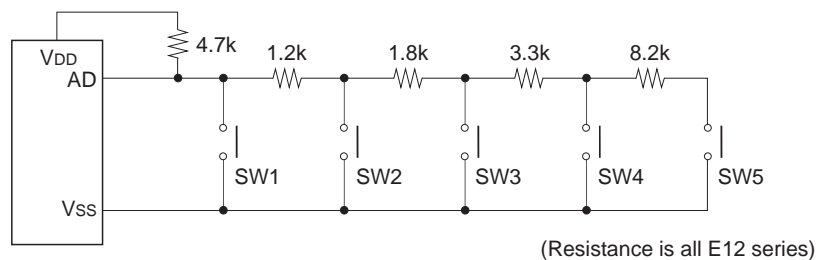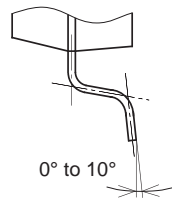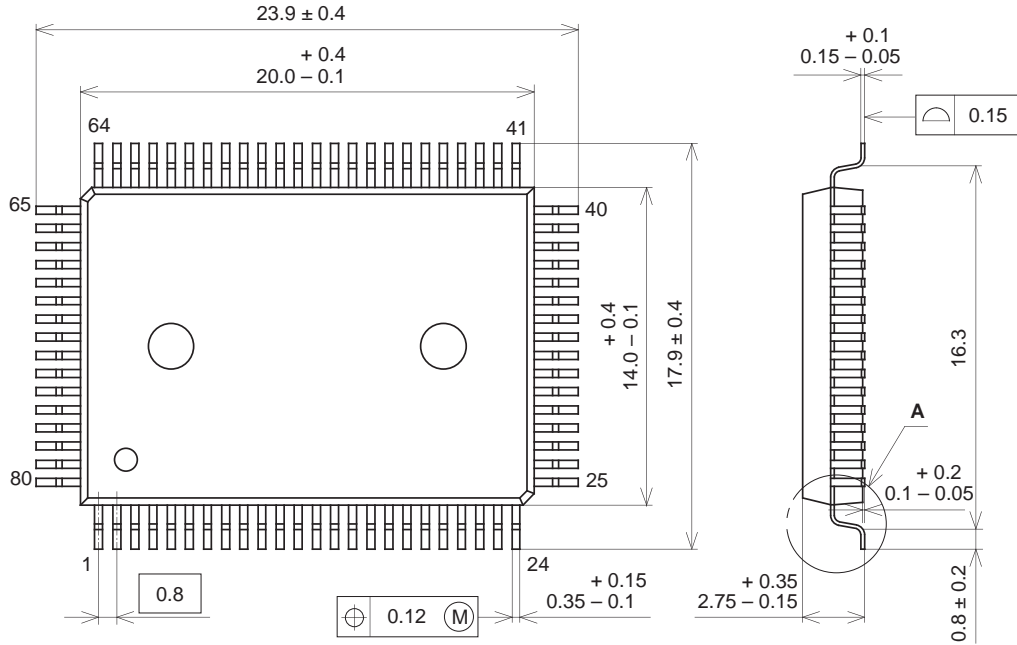

(Resistance is all E12 series)

Fig. 14. Recommended example of key circuit by A/D converter

Package Outline　　　　Unit: mm

80PIN QFP (PLASTIC)

DETAIL **A**

SONY CODE	QFP-80P-L01
EIAJ CODE	QFP080-P-1420
JEDEC CODE	————

PACKAGE STRUCTURE

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	42/COPPER ALLOY
PACKAGE MASS	1.6g